

## DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION Declaration Submitted With Initial Filing Declaration Submitted After Initial Filing Examiner Name:

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter, which is claimed and for which a patent is sought on the invention entitled:

METHOD FOR MANUFACTURING COMPOUND SEMICONDUCTOR EPITAXIAL SUBSTRATE

(Title of Invention)

## the specification of which:

П	is atta	ched	hereto	. or

was filed by an authorized person on my behalf on November 8, 2004 as United States Application Number PCT/JP2004/016905 or PCT International Application Number \_\_\_\_\_, and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below, and I have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application, on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed:

## **Attorney Docket No.**

Prior Foreign Appli			Foreign	Priority	Atta	ed Copy ched	
<u>Numbe</u>	<u>r(s)</u>	Country	Filing Date	Claimed	<u>Yes</u>	<u>No</u>	
2003-3821	16	JAPAN	Nov. 12, 200	3 🛛			
				. 🗆			
<ul><li>Additional f attached he</li></ul>		cation numbers	are listed on a	a supplemental	priority o	lata sheet	
I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below:							
Provisional Application <a href="Mailto:Number(s)">Number(s)</a>		Prov	Provisional Application Filing Date				
□ Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.  I hereby claim the benefit under Title 35, United States Code, § 120, of any prior United States application(s), or under § 365(c) of any PCT international application(s) designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge							
in Title 37. Code	of Federal	ormation known Regulations, §1. nd the national o	56, which becar	ne available be	tween the	filing date	
Prior U.S <u>Application N</u>		Prior PCT International oplication Numb	Filing of U.S. Interna er Appl	or PCT	Patent N (if appli		
<ul> <li>Additional U.S. or PCT international application numbers are listed on a supplemental priority data sheet attached hereto.</li> <li>As a named inventor, I hereby appoint the practitioners associated with Customer Number</li> </ul>							
42798 with full transact all bus and request the	power of s siness in the at all corre	reby appoint the substitution and the United States is spondence and N, TABIN & F	revocation, to Patent and Trac telephone call	prosecute this demark Office o s in respect to	s applicat connected this app	ion and to therewith, lication be	

20035, Telephone No. (202) 419-7000, Facsimile No. (202) 419-7007, CUSTOMER NUMBER

42798.

## **Attorney Docket No.**

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity or enforceability of the application or any patent issued thereon.

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